IRL640S, SiHL640S



RoHS

HALOGEN

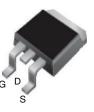
FREE

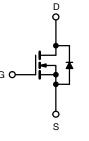


Power MOSFET

| PRODUCT SUMMARY | | | | | | |
|--------------------------|----------------|------|--|--|--|--|
| V _{DS} (V) | 200 | | | | | |
| R _{DS(on)} (Ω) | $V_{GS} = 5 V$ | 0.18 | | | | |
| Q _g max. (nC) | 66 | | | | | |
| Q _{gs} (nC) | 9.0 | | | | | |
| Q _{gd} (nC) | 38 | | | | | |
| Configuration | Single | | | | | |

D²PAK (TO-263)





N-Channel MOSEET

FEATURES

- Surface mount
- Available in tape and reel
- Dynamic dV/dt rating
- Repetitive avalanche rated
- Logic-level gate drive
- R_{DS(on)} specified at V_{GS} = 4 V and 5 V
- Fast switching
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

Note

This datasheet provides information about parts that are RoHS-compliant and / or parts that are non-RoHS-compliant. For example, parts with lead (Pb) terminations are not RoHS-compliant. Please see the information / tables in this datasheet for details.

DESCRIPTION

Third generation power MOSFETs from Vishay provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

The D²PAK is a surface mount power package capable of accommodating die sizes up to HEX-4. It provides the highest power capability and the lowest possible on-resistance in any existing surface mount package. The D²PAK is suitable for high current applications because of its low internal connection resistance and can dissipate up to 2.0 W in a typical surface mount application.

| ORDERING INFORMATION | | | | | | | |
|---------------------------------|-----------------------------|------------------------------|------------------------------|--|--|--|--|
| Package | D ² PAK (TO-263) | D ² PAK (TO-263) | D ² PAK (TO-263) | | | | |
| Lead (Pb)-free and Halogen-free | SiHL640S-GE3 | SiHL640STRL-GE3 ^a | SiHL640STRR-GE3 ^a | | | | |
| Lood (Ph) free | IRL640SPbF | | IRL640STRRPbF ^a | | | | |
| Lead (Pb)-free | SiHL640S-E3 | SiHL640STL-E3 ^a | SiHL640STR-E3 ^a | | | | |

Note

a. See device orientation.

| ABSOLUTE MAXIMUM RATINGS (To | _c = 25 °C, unl | ess otherwis | se noted) | | | |
|--|---------------------------|--|-----------------------------------|-------------|------|--|
| PARAMETER | SYMBOL | LIMIT | UNIT | | | |
| Drain-Source Voltage | V _{DS} | 200 | v | | | |
| Gate-Source Voltage | V _{GS} | ± 10 | v | | | |
| Continuous Drain Current | V at E 0 V | T _C = 25 °C | - I _D | 17 | | |
| Continuous Drain Current | V _{GS} at 5.0 V | $V_{GS} \text{ at } 5.0 \text{ V} \qquad T_C = 25 \text{ °C} \\ T_C = 100 \text{ °C} $ | | 11 | А | |
| Pulsed Drain Current ^a | | | I _{DM} | 68 | | |
| Linear Derating Factor | | | 1.0 | W/°C | | |
| Linear Derating Factor (PCB mount) e | | 0.025 | V/C | | | |
| Single Pulse Avalanche Energy ^b | | | E _{AS} | 580 | mJ | |
| Repetitive Avalanche Current ^a | | | I _{AR} | 10 | А | |
| Repetitive Avalanche Energy ^a | | | E _{AR} | 13 | mJ | |
| Maximum Power Dissipation | D | 125 | w | | | |
| Maximum Power Dissipation (PCB mount) e | T _A = | 25 °C | PD | 3.1 | V | |
| Peak Diode Recovery dV/dt ^c | dV/dt | 5.0 | V/ns | | | |
| Operating Junction and Storage Temperature Ran | ge | | T _J , T _{stg} | -55 to +150 | - °C | |
| Soldering Temperature ^d | for | 10 s | | 300 | -0 | |

Notes

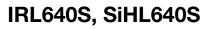
a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11). b. V_{DD} = 50 V, starting T_J = 25 °C, L = 3.0 mH, R_g = 25 Ω , I_{AS} = 17 A (see fig. 12).

c. $I_{SD} \le 17$ A, dI/dt ≤ 150 A/µs, $V_{DD} \le V_{DS}$, $T_J \le 150$ °C.

d. 1.6 mm from case.

e. When mounted on 1" square PCB (FR-4 or G-10 material).

S16-0763-Rev. D, 02-May-16





| THERMAL RESISTANCE RATINGS | | | | | | | |
|---|-------------------|------|------|------|------|--|--|
| PARAMETER | SYMBOL | MIN. | TYP. | MAX. | UNIT | | |
| Maximum Junction-to-Ambient | R _{thJA} | - | - | 62 | | | |
| Maximum Junction-to-Ambient (PCB mount) ^a | R _{thJA} | - | - | 40 | °C/W | | |
| Maximum Junction-to-Case (Drain) | R _{thJC} | - | - | 1.0 | | | |

Note

a. When mounted on 1" square PCB (FR-4 or G-10 material).

| PARAMETER | SYMBOL | TES | T CONDITIONS | MIN. | TYP. | MAX. | UNIT | |
|---|-----------------------|---|---|------------|-----------|----------------------|------------------|--|
| Static | | | | | | • | | |
| Drain-Source Breakdown Voltage | V _{DS} | V _{GS} | = 0, I _D = 250 μA | 200 | - | - | V | |
| V _{DS} Temperature Coefficient | $\Delta V_{DS}/T_{J}$ | Reference | Reference to 25 °C, $I_D = 1 \text{ mA}$ | | | - | V/°C | |
| Gate-Source Threshold Voltage | V _{GS(th)} | V _{DS} = | : V _{GS} , I _D = 250 μΑ | 1.0 | - | 2.0 | V | |
| Gate-Source Leakage | I _{GSS} | | - | - | ± 100 | nA | | |
| Zara Cata Valtaga Drain Current | I _{DSS} | V _{DS} = | V _{DS} = 200 V, V _{GS} = 0 V | | - | 25 | | |
| Zero Gate Voltage Drain Current | | V _{DS} = 160 \ | ′, V _{GS} = 0 V, T _J = 125 °C | - | - | 250 | μA | |
| Drain Sauras On State Registeres | Р | $V_{GS} = 5.0 V$ | I _D = 10 A ^b | - | - | 0.18 | 0 | |
| Drain-Source On-State Resistance | R _{DS(on)} | $V_{GS} = 4.0 V$ | I _D = 8.5 A ^b | - | - | 0.27 | Ω | |
| Forward Transconductance | 9 _{fs} | V _{DS} = | 50 V, I _D = 10 A ^b | 16 | - | - | S | |
| Dynamic | | • | | • | • | • | | |
| Input Capacitance | C _{iss} | | $V_{GS} = 0 V$, | - | 1800 | - | | |
| Output Capacitance | C _{oss} | | $V_{DS} = 25 V,$ | - | 400 | - | pF | |
| Reverse Transfer Capacitance | C _{rss} | f = 1 | 0 MHz, see fig. 5 | - | 120 | - | | |
| Total Gate Charge | Qg | | | - | - | 66 | nC | |
| Gate-Source Charge | Q _{gs} | $V_{GS} = 5.0 V$ | I _D = 17 A, V _{DS} = 160 V, see fig. 6 and 13 ^b | - | - | 9.0 | | |
| Gate-Drain Charge | Q _{gd} | | see lig. 6 and 10 | - | - | 38 | | |
| Turn-On Delay Time | t _{d(on)} | | | - | 8.0 | - | | |
| Rise Time | t _r | V _{DD} = 100 V, I _D = 17 A, | | - | 83 | - | | |
| Turn-Off Delay Time | t _{d(off)} | $R_g = 4.6 \Omega$, | $R_D = 5.7 \Omega$, see fig. 10 ^b | - | 44 | - | ns | |
| Fall Time | t _f | | | - | 52 | - | | |
| Internal Drain Inductance | L _D | 6 mm (0.25") | Between lead, 6 mm (0.25") from | | 4.5 | - | nH | |
| Internal Source Inductance | L _S | die contact | | - | 7.5 | - | | |
| Gate Input Resistance | Rg | f = 1 | MHz, open drain | 0.3 | - | 1.2 | Ω | |
| Drain-Source Body Diode Characteristic | s | - | | | | | | |
| Continuous Source-Drain Diode Current | ا _S | MOSFET sym | bol | - | - | 17 | | |
| Pulsed Diode Forward Current ^a | I _{SM} | integral revers | showing the integral reverse p - n junction diode | | | 68 | A | |
| Body Diode Voltage | V _{SD} | T _J = 25 °C | , I _S = 17 A, V _{GS} = 0 V ^b | - | - | 2.0 | V | |
| Body Diode Reverse Recovery Time | t _{rr} | T 05 %0 1 | | - | 310 | 470 | ns | |
| Body Diode Reverse Recovery Charge | Q _{rr} | $I_{\rm J} = 25 {}^{\circ}{\rm C}, I_{\rm F}$ | = 17 A, dl/dt = 100 A/µs ^b | - | 3.2 | 4.8 | μC | |
| Forward Turn-On Time | t _{on} | Intrinsic tu | rn-on time is negligible (turn | -on is dor | ninated b | y L _S and | L _D) | |

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).

b. Pulse width \leq 300 µs; duty cycle \leq 2 %.



TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

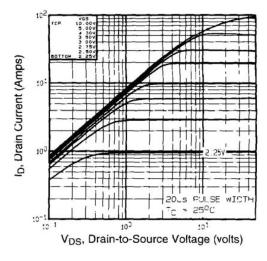


Fig. 1 - Typical Output Characteristics, $T_C = 25 \ ^{\circ}C$

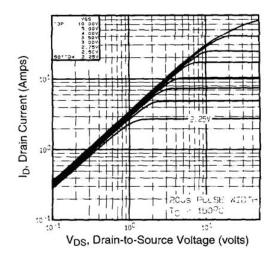


Fig. 2 - Typical Output Characteristics, T_C = 150 °C

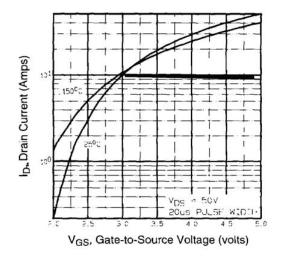


Fig. 3 - Typical Transfer Characteristics

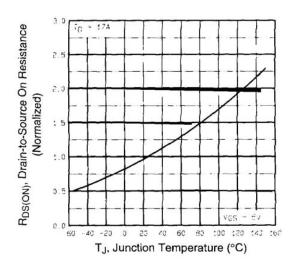


Fig. 4 - Normalized On-Resistance vs. Temperature



IRL640S, SiHL640S

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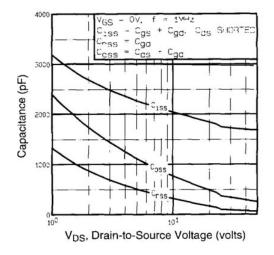
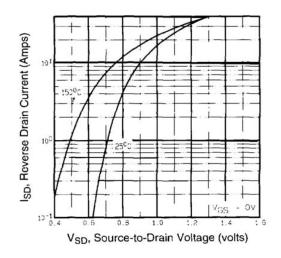
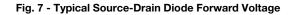


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage





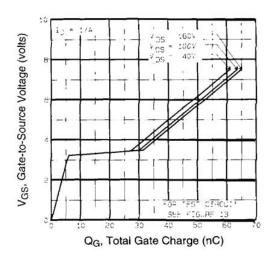


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

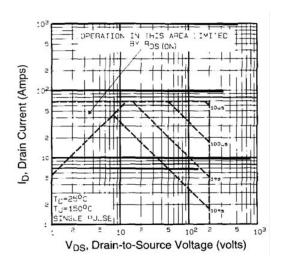


Fig. 8 - Maximum Safe Operating Area



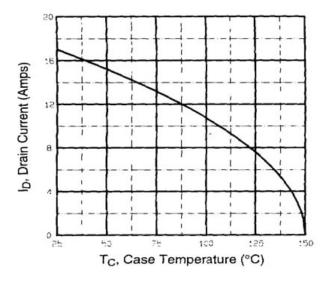


Fig. 9 - Maximum Drain Current vs. Case Temperature

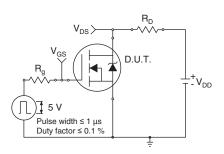


Fig. 10a - Switching Time Test Circuit

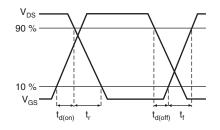


Fig. 10b - Switching Time Waveforms

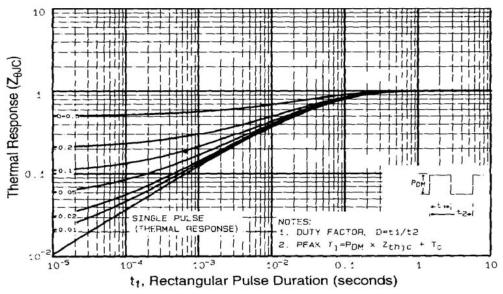


Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Case



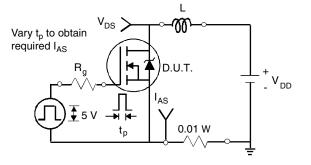


Fig. 12a - Unclamped Inductive Test Circuit

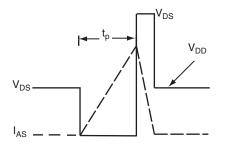


Fig. 12b - Unclamped Inductive Waveforms

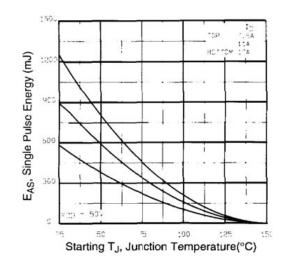
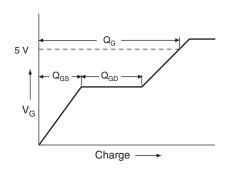


Fig. 12c - Maximum Avalanche Energy vs. Drain Current





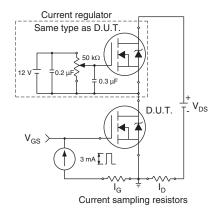


Fig. 13b - Gate Charge Test Circuit

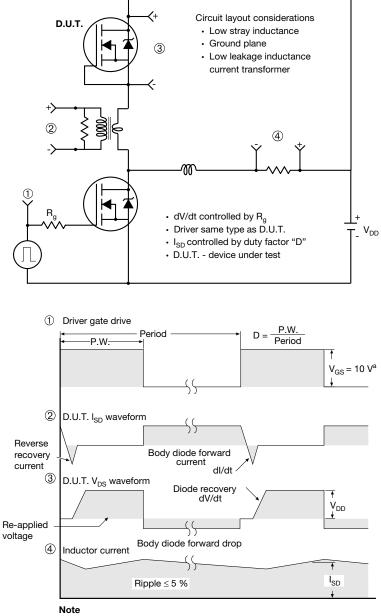
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IRL640S, SiHL640S





Peak Diode Recovery dV/dt Test Circuit



a. $V_{GS} = 5 V$ for logic level devices

Fig. 14 - For N-Channel

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H

A1

B

Gauge plane

L3

Detail "A" Rotated 90° CW scale 8:1

0° to 8° **Vishay Siliconix**

Seating plane

TO-263AB (HIGH VOLTAGE)

/3 ⁄4 A

н

∕₅∖

Detail A

(Datum A)

D

 $\underline{4}$ 11

| | 2 | - | Y 2 x b2 2 x b ⊕ 0.010 @ A(| ■ ating 5 b1, b b1, b b1, b c) c) c) c) c) c) c) c) c) c) | $\begin{array}{c} c_{1} \\ c_{1} \\ c_{2} \\ c_{3} \\ c_{4} \\ c_{5} \\ c_{7} \\$ | a - 1 | | Ū. | 1 <u>4</u> | |
|--------------------------------|--|--|--|---|---|-------------------------------|---|---|--|--|
| | MILLIN | IETERS | INCHES | | | | MILLIMETERS | | INCHES | |
| DIM. | MIN. | MAX. | MIN. | MAX. | | DIM. | MIN. | MAX. | MIN. | MAX. |
| А | 4.06 | 4.83 | 0.160 | 0.190 | | D1 | 6.86 | - | 0.270 | - |
| | | | | 0.010 | | - | | 10.07 | 0.000 | 0.420 |
| A1 | 0.00 | 0.25 | 0.000 | 0.010 | | E | 9.65 | 10.67 | 0.380 | 0.120 |
| A1 b | 0.00 0.51 | 0.25 0.99 | 0.000 | 0.010 | | E1 | 9.65 6.22 | - 10.67 | 0.380 | - |
| | | | | | | | 6.22 | - 10.67 - BSC | 0.245 | - BSC |
| b | 0.51 | 0.99 | 0.020 | 0.039 | | E1 | 6.22 | - | 0.245 | - |
| b b1 | 0.51 0.51 | 0.99 0.89 | 0.020 0.020 | 0.039 0.035 | | E1 e | 6.22 2.54 | - BSC | 0.245 | -) BSC |
| b b1 b2 | 0.51 0.51 1.14 | 0.99 0.89 1.78 | 0.020 0.020 0.045 | 0.039 0.035 0.070 | | E1 e H | 6.22 2.54 14.61 | - BSC 15.88 | 0.245 0.100 0.575 | -) BSC 0.625 |
| b b1 b2 b3 | 0.51 0.51 1.14 1.14 | 0.99 0.89 1.78 1.73 | 0.020 0.020 0.045 0.045 | 0.039 0.035 0.070 0.068 | | E1 e H L | 6.22 2.54 14.61 1.78 | - BSC 15.88 2.79 | 0.245 0.100 0.575 0.070 | - 0 BSC 0.625 0.110 |
| b b1 b2 b3 c | 0.51 0.51 1.14 1.14 0.38 | 0.99 0.89 1.78 1.73 0.74 | 0.020 0.020 0.045 0.045 0.015 | 0.039 0.035 0.070 0.068 0.029 | | E1 e H L L1 | 6.22 2.54 14.61 1.78 - - | - BSC 15.88 2.79 1.65 | 0.245 0.100 0.575 0.070 - - | - 0 BSC 0.625 0.110 0.066 |
| b b1 b2 b3 c c1 | 0.51 0.51 1.14 1.14 0.38 0.38 | 0.99 0.89 1.78 1.73 0.74 0.58 | 0.020 0.020 0.045 0.045 0.015 0.015 | 0.039 0.035 0.070 0.068 0.029 0.023 | | E1 e H L L1 L2 | 6.22 2.54 14.61 1.78 - - | - BSC 15.88 2.79 1.65 1.78 | 0.245 0.100 0.575 0.070 - - | - 0 BSC 0.625 0.110 0.066 0.070 |

Α

Notes

1. Dimensioning and tolerancing per ASME Y14.5M-1994.

2. Dimensions are shown in millimeters (inches).

3. Dimension D and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outmost extremes of the plastic body at datum A.

4. Thermal PAD contour optional within dimension E, L1, D1 and E1.

5. Dimension b1 and c1 apply to base metal only.

6. Datum A and B to be determined at datum plane H.

7. Outline conforms to JEDEC outline to TO-263AB.



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